



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Receipt 2800

In re the Application of

John P. Tellkamp

Docket No.: TI-30628

N 10-09-02

Serial No.: 09/907,237

Examiner: Graybill, D.

Filed

07/12/01

Art Unit: 2827

For:

SEMICONDUCTOR LEADFRAMES COMPRISING SILVER PLATING

SECOND REQUEST FOR CORRECTED FILING RECEIPT

September 25, 2002

Assistant Commissioner for Patents
Washington, DC 20231

Attn: Office of Initial Patent Examination's
Filing Receipt Corrections

Dear Sir:

MAILING CERTIFICATE	
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231.	
<i>Marianna Smith</i>	<u>9-25-02</u>
Marianna Smith	Date

The Filing Receipt dated 09/04/01 erroneously indicates a filing date of 07/17/2001. A Request for Corrected Filing Date was mailed to the U.S. Patent and Trademark Office by Gary C. Honeycutt on September 4, 2001. A copy of that request along with the documentation is enclosed.

Issuance of a corrected Filing Receipt indicating the correct filing date of **07/12/2001** is respectfully requested.

Please charge any necessary fees to Deposit Account No. 20-0668. An original and two copies of this sheet are enclosed.

Respectfully submitted,

Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, TX 75265
(972) 917-5653

Michael K. Skrehot
Registration No. 36,682
Attorney for Applicant

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In The "Received" stamp of the Patent and Trademark Office imprinted hereon acknowledges the filing of:

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<input type="checkbox"/> CONTINUATION APP'N	<input type="checkbox"/> REPLY BRIEF (IN TRIPLICATE)
<input type="checkbox"/> DIVISIONAL APP'N	<input checked="" type="checkbox"/> Request for Corrected Filing Date

NAME OF INVENTOR(S): Tellkamp	RECEIPT DATE & SERIAL NO.: Serial No.: 09/907,237
TITLE OF INVENTION: Semiconductor Leadframes comprising Silver Plating	SEP 10 2001
TI FILE NO.: T1-30628	DEPOSIT ACCT. NO.: 20-0668
EXPRESS MAIL RECEIPT NO.: MLD: 9/4/01 DUE: ATTY/SECY: GCH/ccc	

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TI PATENT DEPT

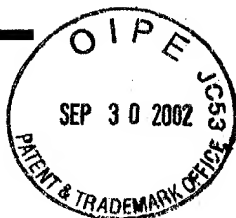
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G O D W I N W H I T E G R U B E R

GARY C. HONEYCUTT
Direct Dial: 972.238.7160
ghoneycutt@godwinwhitegruber.com



September 4, 2001

Attorneys
A Professional Corporation
TELECOM CORRIDOR®
801 E. Campbell Road, Suite 655
Richardson, Texas 75081-1890
972.238.7160
972.238.7013 Fax
DALLAS
214.939.4400
godwinwhitegruber.com

VIA FIRST CLASS MAIL

Assistant Commissioner for Patents
Washington, D.C. 20231-9998

Re: Request for Corrected Mailing Date for:
Title: **SEMICONDUCTOR LEADFRAMES COMPRISING SILVER
PLATING**
Serial No.: 09/907,237
Filing date: 07/147/01
TI File No: TI-30628
Our File No: 50000.2148

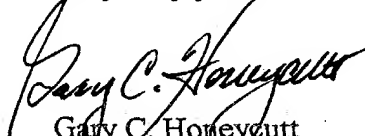
Dear Sir:

Enclosed please find the following items relating to the above-identified patent:

- (1) Request for Corrected Filing Date;
- (2) Copy of Application Transmittal Form Showing Express Mailing Date;
- (3) USPS History; and
- (4) Postcards.

Please return the date-stamped postcard to our offices at the above address. In the meantime if you have any questions or comments concerning this matter, please call the undersigned at your earliest convenience. Otherwise, please accept the enclosed.

Very truly yours,


Gary C. Honeycutt
Reg. No. 20,250

GCH/ecc
Enclosures
cc: Lawrence Bassuk, Texas Instruments Incorporated

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tellkamp
Serial No.: 09/907237
Filed: 07/12/2001
Docket: TI-30628
For: SEMICONDUCTOR LED FRAMES COMPRISING SILVER PLATING.

REQUEST FOR CORRECTED FILING DATE

September 4, 2001

Assistant Commissioner
for Patents
Washington, D.C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. 1.8 (A)
I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail bearing sufficient postage in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on September 4, 2001.

Nancy Thornton
Nancy Thornton

9/4/2001.

Sir:

Applicant received a postcard indicating a filing date of July 17, 2001 for the above referenced Application.

However, the Mailing Certificate indicates that the Application was deposited with the U.S. Postal Service Express Mail (Label No. EL897699426US) on July 12, 2001.

In addition, we are enclosing a U.S. Postal Service Shipment History, indicating that the package with label No. 897699426US was in EN ROUTE July 13, at 5:33pm.

Applicant requests that the filing date be corrected to **July 12, 2001** to reflect the date of mailing.

Respectfully Submitted,

Gary C. Honeycutt
Gary C. Honeycutt

Reg. No. 20,250

Attorney for Applicant

Godwin Gruber, P.C.
801 E. Campbell Rd. Suite 655
Richardson, Texas 75081
(972) 238-7160
(972) 238-7013 - Fax

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Shipment History

You entered EL897699426US

Your item was delivered at 10:57 am on July 18 in WASHINGTON DC 20231 to M Andenson.

Here is what happened earlier:

- ARRIVAL AT UNIT, July 18, 9:41 am, 20096
- ARRIVAL AT UNIT, July 14, 9:35 am, RICHARDSON TX 75081
- ARRIVAL AT UNIT, July 14, 8:08 am, RICHARDSON TX 75080
- **ENROUTE, July 13, 5:33 pm**

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G O D W I N I T E G R U B E R

GARY C. HONEYCUTT
Direct Dial: 972.238.7160
ghoneycutt@godwinwhitegruber.com



July 12, 2001

Attorneys
A Professional Corporation

TELECOM CORRIDOR®
801 E. Campbell Road, Suite 655
Richardson, Texas 75081-1890
972.238.7160
972.238.7013 Fax

DALLAS
214.939.4400

godwinwhitegruber.com

VIA EXPRESS MAIL

Assistant Commissioner for Patents
Washington, D.C. 20231

EL897699426US

Re: Patent Application for
"SEMICONDUCTOR LEADFRAMES COMPRISING SILVER PLATING"
Attorney Docket No. TI-30628
Our File: 1000-2154

Dear Sir:

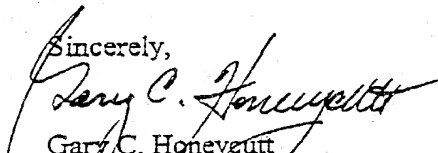
Enclosed for filing please find the following items relating to the above-identified application:

- (1) Declaration, and Power of Attorney;
- (2) Non-Provisional Application;
- (3) Fee Authorization/transmittal Form ;
- (4) Recordation Form Cover Sheet with Assignment;
- (5) Specifications; formal drawings; and
- (6) Postcards.

Please charge Deposit Account No. 20-0668 in the amount of the total fees set forth. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 20-0668.

Please file the application and return the date-stamped postcard to the corresponding addresses as indicated. In the meantime, if you have any questions or comments concerning this matter, please call the undersigned. Otherwise, please accept the enclosed.

Sincerely,


Gary C. Honeycutt
Reg. No. 20,250

GCH/gdw
Enclosures

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NON-PROVISIONAL APPLICATION FOR U. S. PATENT UNDER 37 CFR 1.53(b)
TRANSMITTAL FORM

Attorney Docket No. TI-30628

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

Transmitted herewith for filing is the
patent application of

Inventor(s): John P. Tellkamp

"EXPRESS MAILING" Mailing Label No.
EL 897699426 US Date of Deposit: July 12, 2001.
I hereby certify that this paper is being deposited with the
U.S. Postal Service Express Mail Post Office to Addressee
Service under 37 CFR 1.10 on the date shown above and is
addressed to the Assistant Commissioner for Patents,
Washington, D.C. 20231.

Glenda West

Date

Glenda West 07/12/01

For: "SEMICONDUCTOR LEADFRAMES COMPRISING SILVER PLATING"
Enclosed are:

- 4 Sheets of formal drawings and 29 pages of Specification (including Abstract)
- x A Declaration/Power of Attorney
- x Assignment with form PTO 1595

Please amend the specification by inserting before the first line the sentence:

This application claims priority under 35 USC § 119 based upon Provisional Patent Application
numbers 60/217.964, filed 07/13/2000.

FEE CALCULATION					FEE
	NUMBER		NUMBER EXTRA	RATE	BASIC FEE \$ 710.00
Total Claims	23	-20 =	3	3 X \$22 =	66.00
Independent Claims	5	- 3 =	2	X \$82 =	164.00
Total Filing Fee					\$ 940.00

Please charge Deposit Account No. 20-0668 in the amount of the Total Fees set forth. The
Commissioner is hereby authorized to charge any additional fees which may be required, or credit
any overpayment to Deposit Account No. 20-0668. This form is submitted in triplicate.

All correspondence related to this application may be addressed to the undersigned at Navarro IP
Law Group, P.C. 801 E. Campbell Rd. Suite 655, Richardson, TX 75081.

Date: July 12, 2001

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Gary C. Hargrett
Registration No. 20,250



September 4, 2001

RE: Request for Corrected Filing Date for:
SEMICONDUCTOR LEADFRAMES COMPRISING SILVER PLATING
Our File No.: 50000.2148

Enclosed with this postcard, please find the following:

1. Request for Corrected Filing Date;
2. Copy of Non-Provisional Application Showing Original Mailing Date;
3. USPS History; and
4. Postcards.

Please date stamp this postcard to indicate that the above materials have been received and return to our office at the address on the back of this postcard.

Thank You

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<input type="checkbox"/> DIVISIONAL APP'N	<input checked="" type="checkbox"/> <i>Request for Corrected Filing Date</i>
NAME OF INVENTOR(S): <i>Tellkamp</i>	RECEIPT DATE & SERIAL NO.: <i>Date</i>
TITLE OF INVENTION: <i>Semiconductor Leadframes Comprising Silver Plating</i>	Serial No.: <i>69/907,237</i>
TI FILE NO.: <i>T1-30628</i>	DEPOSIT ACCT. NO.: <i>20-0668</i>
EXPRESS MAIL RECEIPT NO.: MLD: <i>9/4/01</i> DUE: ATTY/SECY: <i>GCH/CC</i>	